



PATENT
P-US024-A-MF

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Cohen, et al. Customer No: 32107
Assignee: Microfabrica Inc. Docket No: P-US024-A-MF
Title: Method for Electrochemically Forming Structures Including Non-Parallel Mating of Contact Masks and Substrates
Application No: 10/724,515 Filing Date: November 26, 2003
Examiner: Culbert, Roberts P. Group Art Unit: 1763

COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, VA 22313-1450

November 9, 2006

AMENDMENT

Dear Sir:

Applicant makes this submission in response to the Office action dated August 9, 2006 for the above noted application.

Amendments to the Specification begin on page 2 of this paper and include both a replacement specification and an original specification with underline/strikeout markings.

Remarks begin on page 3 of this paper.

An **Appendix A** provides a replacement specification and is attached following page 3 of this paper.

An **Appendix B** provides a mark up of the original specification with amendments indicated by underlining and strikeouts and is attached following Appendix A of this paper.